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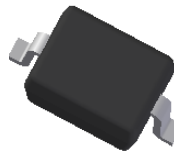
Features

- Low Forward Voltage Drop
- Low Reverse Leakage
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, fast switching capability
- +150°C Operating Junction Temperature
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound.
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.004 grams (Approximate)

SOD323



Top View

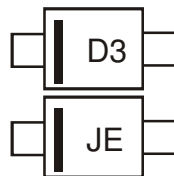
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|--------|-------------------|
| SBR130S3-7 | SOD323 | 3,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information

SOD323



D3, JE = Product Type Marking Code

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|--------------|-------|------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 30 | V |
| Working Peak Reverse Voltage | V_{RWM} | | |
| DC Blocking Voltage | V_{RM} | | |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 21 | V |
| Average Rectified Output Current (Note 6) | I_O | 1 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I_{FSM} | 20 | A |

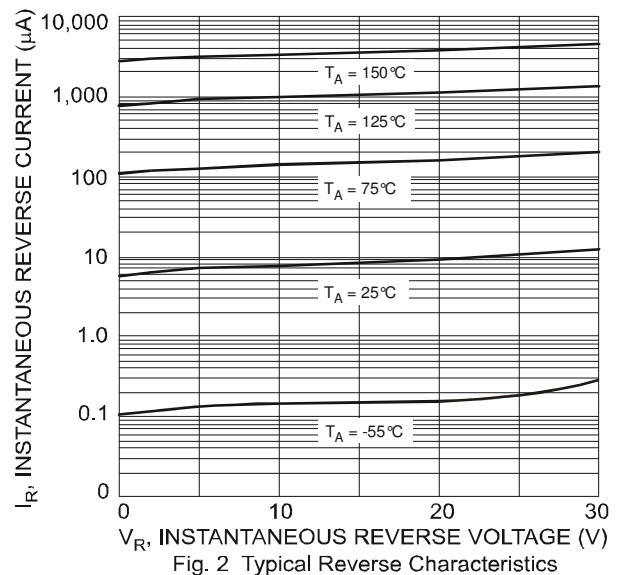
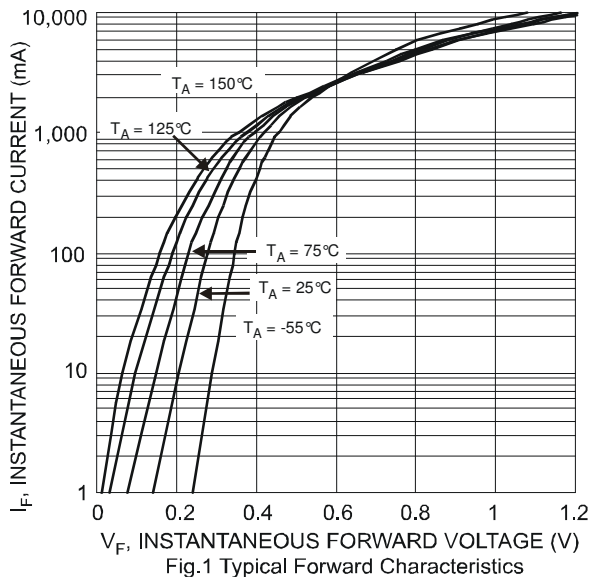
Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Thermal Resistance Junction to Ambient (Note 5) | $R_{\theta JA}$ | 488 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -65 to +150 | $^\circ\text{C}$ |

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|------------------------------------|-------------|-----|------|------|---------------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$ | 30 | - | - | V | $I_R = 200\mu\text{A}$ |
| Forward Voltage Drop | V_F | - | 0.39 | 0.43 | V | $I_F = 700\text{mA}, T_J = +25^\circ\text{C}$ |
| | | - | 0.31 | 0.34 | | $I_F = 700\text{mA}, T_J = +125^\circ\text{C}$ |
| | | - | 0.42 | 0.46 | | $I_F = 1\text{A}, T_J = +25^\circ\text{C}$ |
| | | - | 0.36 | 0.39 | | $I_F = 1\text{A}, T_J = +125^\circ\text{C}$ |
| Leakage Current (Note 7) | I_R | - | 8.0 | 20 | μA | $V_R = 10\text{V}, T_J = +25^\circ\text{C}$ |
| | | - | 4.0 | 10 | mA | $V_R = 10\text{V}, T_J = +125^\circ\text{C}$ |
| | | - | 12 | 50 | μA | $V_R = 30\text{V}, T_J = +25^\circ\text{C}$ |
| | | - | 5 | 15 | mA | $V_R = 30\text{V}, T_J = +125^\circ\text{C}$ |
| | | - | - | - | - | - |

Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
6. Part mounted on 50mm X 50mm 2oz copper pad.
7. Short duration pulse test used to minimize self-heating effect.



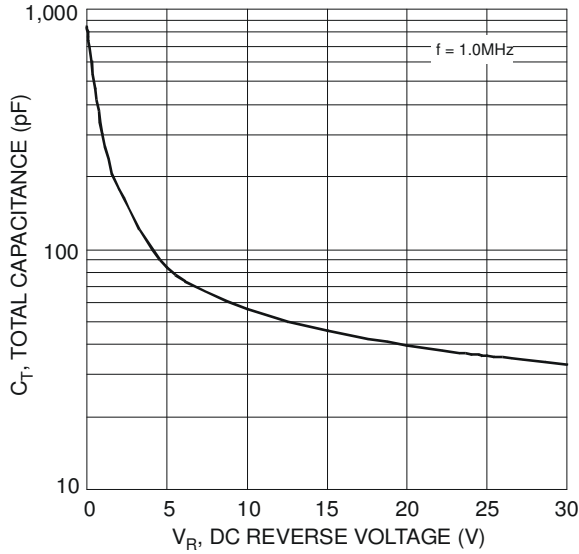


Fig. 3 Total Capacitance vs. Reverse Voltage

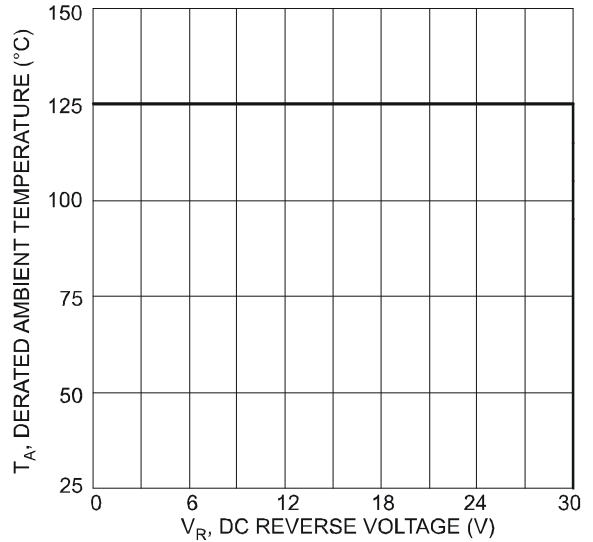
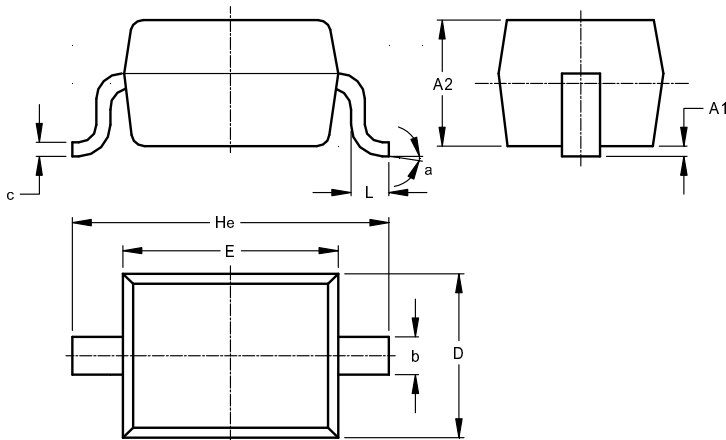


Fig. 4 Operating Temperature Derating

Package Outline Dimensions

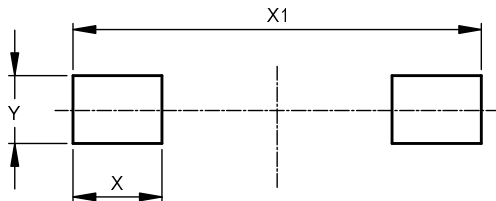
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| SOD323 | | | |
|----------------------|------|------|------|
| Dim | Min | Max | Typ |
| A1 | -- | 0.10 | 0.05 |
| A2 | 1.00 | 1.10 | 1.05 |
| b | 0.25 | 0.35 | 0.30 |
| c | 0.10 | 0.15 | 0.11 |
| D | 1.20 | 1.40 | 1.30 |
| E | 1.60 | 1.80 | 1.70 |
| He | 2.30 | 2.70 | 2.50 |
| L | 0.20 | 0.40 | 0.30 |
| a | 8° | | |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| X | 0.590 |
| X1 | 2.700 |
| Y | 0.450 |

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